



IDC05S120E

1200V thinQ!TM SiC Schottky Diode

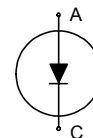
Features:

- Revolutionary Semiconductor Material - Silicon Carbide
- Switching Behaviour Benchmark
- No Reverse Recovery / No Forward Recovery
- Temperature Independent Switching Behaviour
- Qualified According to JEDEC¹⁾ Based on Target Applications

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Applications:

- Motor Drives / Solar Inverters
- High Voltage CCM PFC
- Switch Mode Power Supplies
- High Voltage Multipliers



| Chip Type | V _{BR} | I _F | Die Size | Package |
|------------|-----------------|----------------|-------------------------------|--------------|
| IDC05S120E | 1200V | 5A | 1.692 x 1.692 mm ² | sawn on foil |

Mechanical parameters

| | | |
|---------------------------------|--|-----------------|
| Raster size | 1.692 x 1.692 | mm ² |
| Anode pad size | 1.156 x 1.156 | |
| Area total | 2.86 | |
| Thickness | 362 | µm |
| Wafer size | 100 | mm |
| Max. possible chips per wafer | 2360 | |
| Passivation frontside | Photoimide | |
| Pad metal | 3200 nm Al | |
| Backside metal | Ni Ag –system suitable for epoxy and soft solder die bonding | |
| Die bond | Electrically conductive glue or solder | |
| Wire bond | Al, ≤ 350µm | |
| Reject ink dot size | ∅ ≥ 0.3 mm | |
| Recommended storage environment | Store in original container, in dry nitrogen, in dark environment, < 6 month at an ambient temperature of 23°C | |



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Maximum Ratings

| Parameter | Symbol | Condition | Value | Unit |
|---|-------------------|--|------------|--------------------|
| Repetitive peak reverse voltage | V_{RRM} | $T_{vj} = 25\text{ }^{\circ}\text{C}$ | 1200 | V |
| DC blocking voltage | V_{DC} | | 1200 | |
| Continuous forward current, limited by T_{vjmax} | I_F | $T_{vj} < 150\text{ }^{\circ}\text{C}$ | 5 | A |
| Surge non repetitive forward current, sine halfwave | $I_{F,SM}$ | $T_C = 25\text{ }^{\circ}\text{C}, t_P = 10\text{ ms}$ | 29 | |
| | | $T_C = 150\text{ }^{\circ}\text{C}, t_P = 10\text{ ms}$ | 25 | |
| Repetitive peak forward current, limited by thermal resistance R_{th} | $I_{F,RM}$ | $T_C = 100\text{ }^{\circ}\text{C}, T_{vj} = 150\text{ }^{\circ}\text{C}, D = 0.1$ | 23 | |
| Non-repetitive peak forward current | $I_{F,max}$ | $T_C = 25\text{ }^{\circ}\text{C}, t_P = 10\text{ }\mu\text{s}$ | 110 | |
| i^2t value | $\int i^2 dt$ | $T_C = 25\text{ }^{\circ}\text{C}, t_P = 10\text{ ms}$ | 4 | A ² s |
| | | $T_C = 150\text{ }^{\circ}\text{C}, t_P = 10\text{ ms}$ | 3 | |
| Operating junction and storage temperature range | T_{vj}, T_{stg} | | -55...+175 | $^{\circ}\text{C}$ |

Static Characteristics (tested on wafer)

| Parameter | Symbol | Conditions | Value | | | Unit |
|-----------------------|--------|--|-------|------|------|---------------|
| | | | min. | Typ. | max. | |
| Reverse current | I_R | $V_R = 1200\text{ V}, T_{vj} = 25\text{ }^{\circ}\text{C}$ | | 5 | 120 | μA |
| Diode forward voltage | V_F | $I_F = 5\text{ A}, T_{vj} = 25\text{ }^{\circ}\text{C}$ | | 1.6 | 1.8 | V |

Static Characteristics (not subject to production test - verified by design / characterization)

| Parameter | Symbol | Conditions | Value | | | Unit |
|-----------------------|--------|---|-------|------|------|---------------|
| | | | min. | Typ. | max. | |
| Reverse current | I_R | $V_R = 1200\text{ V}, T_{vj} = 150\text{ }^{\circ}\text{C}$ | | 20 | 1000 | μA |
| Diode forward voltage | V_F | $I_F = 5\text{ A}, T_{vj} = 150\text{ }^{\circ}\text{C}$ | | 2.5 | 3 | V |



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Dynamic Characteristics (not subject to production test - verified by design / characterization)

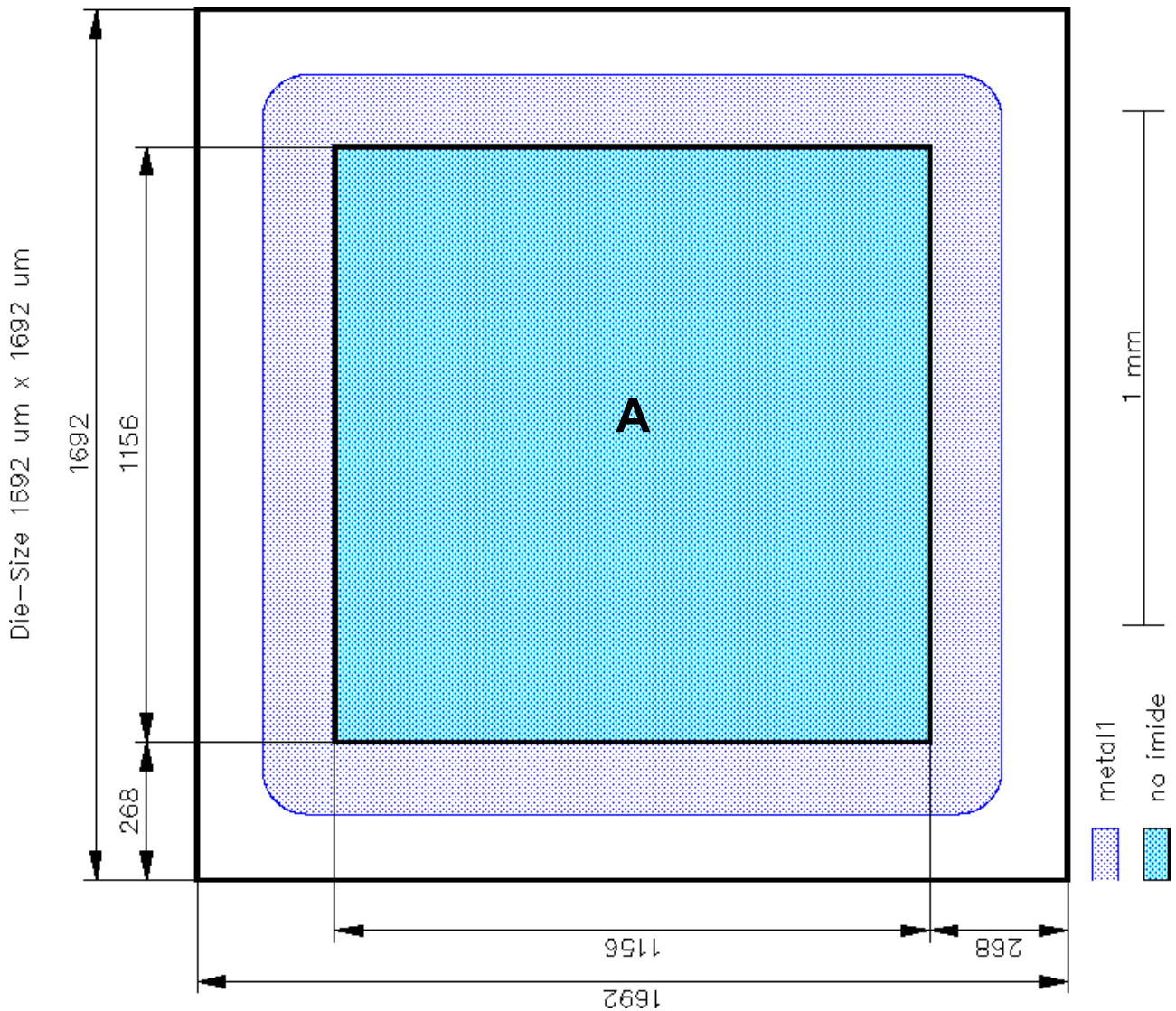
| Parameter | Symbol | Conditions | Value | | | Unit |
|---------------------------------------|--------|---|------------------------|------|------|------|
| | | | min. | Typ. | max. | |
| Total capacitive charge ³⁾ | Q_C | $I_F \leq I_{F,max}$ $di/dt = 200A/\mu s$ $V_R = 1200V$ | | 18 | | nC |
| Switching time ²⁾ | t_c | | $T_{vj} = 150^\circ C$ | | | <10 |
| Total capacitance | C | $f = 1MHz$ | $V_R = 1V$ | 250 | | pF |
| | | | $V_R = 300V$ | 20 | | |
| | | | $V_R = 600V$ | 18 | | |

¹⁾ J-STD20 and JESD22

²⁾ t_c is the time constant for the capacitive displacement current waveform (independent from T_{vj} , I_{LOAD} and di/dt), different from t_{rr} , which is dependent on T_{vj} , I_{LOAD} , di/dt . No reverse recovery time constant t_{rr} due to absence of minority carrier inject.

³⁾ Only capacitive charge occurring, guaranteed by design (independent from T_{vj} , I_{LOAD} and di/dt).

Chip drawing



A: Anode pad



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Description

AQL 0,65 for visual inspection according to failure catalogue

Electrostatic Discharge Sensitive Device according to MIL-STD 883

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